

Service, Repair, and Return Policies and Instructions

The information contained in this document supersedes all similar information that may be found elsewhere in this manual.

Service - Due to the sophisticated nature of the sensors and associated instrumentation provided bγ Piezotronics, user servicing or repair is not recommended and, if attempted, may void the factory warranty. Routine maintenance, such as the cleaning of electrical connectors, housings, and mounting surfaces with solutions and techniques that will not harm the physical material of construction, is acceptable. Caution should be observed to ensure that liquids are not permitted to migrate into devices that are not hermetically sealed. Such devices should only be wiped with a dampened cloth and never submerged or have liquids poured upon them.

Repair – In the event that equipment becomes damaged or ceases to operate, arrangements should be made to return the equipment to PCB Piezotronics for repair. User servicing or repair is not recommended and, if attempted, may void the factory warranty.

Calibration – Routine calibration of sensors and associated instrumentation is recommended as this helps build confidence in measurement accuracy and acquired data. Equipment calibration cycles typically are established by the users own quality regimen. When in doubt about a calibration cycle, a good "rule of thumb" is to recalibrate on an annual basis. It is

also good practice to recalibrate after exposure to any severe temperature extreme, shock, load, or other environmental influence, or prior to any critical test.

PCB Piezotronics maintains an ISO-9001 certified metrology laboratory and offers calibration services, which are accredited by A2LA to ISO/IEC 17025, with full traceability to SI through N.I.S.T. In addition to the normally supplied calibration, special testing is also available, such as: sensitivity at elevated or cryogenic temperatures, phase response, extended high or low frequency response, extended range, testing, hydrostatic leak pressure testing, and others. For information on standard recalibration services special testing, contact your local PCB Piezotronics distributor. sales or factory representative. customer service representative.

Returning **Equipment** – Following these procedures will ensure that your returned materials are handled in the expedient Before most manner. returnina any equipment to PCB Piezotronics, contact your local distributor, sales representative, or factory customer service representative to obtain a Return Warranty, Service, Repair, and Return Policies and Instructions Materials Authorization (RMA) Number. This RMA number should be clearly marked on the outside of all package(s) and on the packing

list(s) accompanying the shipment. A detailed account of the nature of the problem(s) being experienced with the equipment should also be included inside the package(s) containing any returned materials.

A Purchase Order, included with the returned materials, will expedite the turn-around of serviced equipment. It is recommended to include authorization on the Purchase Order for PCB to proceed with any repairs, as long as they do not exceed 50% of the replacement cost of the returned item(s). PCB will provide a price quotation or replacement recommendation for any item whose repair costs would exceed 50% of replacement cost, or any item that is not economically feasible to repair. For routine calibration services. the Order Purchase should include authorization to proceed and return at current pricing, which can be obtained a factory customer service representative.

Contact Information – International customers should direct all inquiries to their local distributor or sales office. A

complete list of distributors and offices found at www.pcb.com. be Customers within the United States may contact their local sales representative or factory customer а representative. A complete list of sales representatives can be found at www.pcb.com. Toll-free telephone numbers for a factory customer service representative. in the division responsible for this product, can be found on the title page at the front of this manual. Our ship to address and general contact numbers are:

PCB Piezotronics, Inc. 3425 Walden Ave. Depew, NY14043 USA Toll-free: (800) 828-8840 24-hour SensorLineSM: (716) 684-0001

Website: www.pcb.com

E-mail: info@pcb.com



PCB工业监视和测量设备 - 中国RoHS2公布表

PCB Industrial Monitoring and Measuring Equipment - China RoHS 2 Disclosure Table

	有害物质								
部件名称	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴 联苯 (PBB)	多溴二苯醚 (PBDE)			
住房	0	0	0	0	0	0			
PCB板	X	0	0	0	0	0			
电气连接器	0	0	0	0	0	0			
压电晶 体	Х	0	0	0	0	0			
环 氧	0	0	0	0	0	0			
铁氟龙	0	0	0	0	0	0			
电子	0	0	0	0	0	0			
厚膜基板	0	0	Х	0	0	0			
电线	0	0	0	0	0	0			
电缆	Х	0	0	0	0	0			
塑料	0	0	0	0	0	0			
焊接	Х	0	0	0	0	0			
铜合金/黄铜	Х	0	0	0	0	0			

本表格依据 SJ/T 11364 的规定编制。

CHINA RoHS COMPLIANCE

O:表示该有害物质在该部件所有均质材料中的含量均在 GB/T 26572 规定的限量要求以下。

X:表示该有害物质至少在该部件的某一均质材料中的含量超出 GB/T 26572 规定的限量要求。 铅是欧洲RoHS指令2011/65/ EU附件三和附件四目前由于允许的豁免。

Component Name	Hazardous Substances								
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Chromium VI Compounds (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)			
Housing	0	0	0	0	0	0			
PCB Board	Х	0	0	0	0	0			
Electrical Connectors	0	0	0	0	0	0			
Piezoelectric Crystals	Х	0	0	0	0	0			
Ероху	0	0	0	0	0	0			
Teflon	0	0	0	0	0	0			
Electronics	0	0	0	0	0	0			
Thick Film Substrate	0	0	Х	0	0	0			
Wires	0	0	0	0	0	0			
Cables	Х	0	0	0	0	0			
Plastic	0	0	0	0	0	0			
Solder	Х	0	0	0	0	0			
Copper Alloy/Brass	Х	0	0	0	0	0			

This table is prepared in accordance with the provisions of SJ/T 11364.

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DOCUMENT REVISION: D

ECN: 46162

O: Indicates that said hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement of GB/T 26572.

X: Indicates that said hazardous substance contained in at least one of the homogeneous materials for this part is above the limit requirement of GB/T 26572.

Lead is present due to allowed exemption in Annex III or Annex IV of the European RoHS Directive 2011/65/EU.

3710 series DC Accelerometer Operating Guide

1.0 Introduction

This operating guide contains information that will familiarize the user with the basic operation and installation of the 3710 Series MEMS DC Accelerometers. However, it is not intended to cover all of the specific measurement challenges that one may encounter while using the device. Therefore, if you have detailed questions or are unsure of how to properly operate the sensor after reading this "Operating Guide", please contact a PCB Application Engineer using our 24-Hour SensorLineTM at 716-684-0001.

2.0 Common Applications and Features

The 3710 Series MEMS DC Accelerometers achieve true DC response for measuring uniform (or constant) acceleration and low-frequency vibration. For this reason, they are often used to:

- Perform ride quality assessments of elevators, automobiles, trains, and amusement park rides.
- Analyze the low frequency characteristics of buildings, bridges, and large aerospace objects.
- Acquire tilt and orientation data for feedback control and stabilization purposes.

Because of the critical nature of these and similar test applications, all 3710 series MEMS DC Accelerometers have been designed and manufactured with the following common characteristics:

- Rugged, all-welded titanium housing insures reliability and durability in demanding applications and environments.
- Built-in microelectronics provide conveniently standardized sensitivities and low-noise output signals unmatched by similar sensing technologies.
- Internal voltage regulator allows sensor to be powered from virtually any unregulated DC voltage source, such as a bench-top power supply or portable battery source.
- Gas damping extends the upper frequency range, attenuates unwanted high-frequency vibration, and provides stable performance over the entire operating temperature range.
- Hermetic, multi-pin connector provides a reliable connection even under the harshest environmental conditions.

3.0 Principle of Operation

The sensor element of the 3710 series features a proof mass, ring frame, and attachment system between the two. These features are bulk micro machined from the same single-crystal silicon wafer. The movement of the proof mass is directly affected by acceleration applied in the axis of sensitivity.

The sensor element is connected as a bridge element in the circuit. The electrical characteristics of one portion of the bridge increase in value while the characteristics of the other portion decrease when exposed to acceleration. This approach minimizes common mode errors and improves non-linearity.

A selection of full scale measurement ranges is attained by modifying the stiffness of the suspension system of the proof mass. A high natural frequency is accomplished through the combination of a lightweight proof mass and suspension stiffness.

Ruggedness is enhanced through the use of mechanical stops on the two outer wafers to restrict the travel of the proof mass. Damping is used to mitigate high frequency inputs.

The sensor elements use squeeze-film gas damping that is near critically damped. This is the result of the movement of the proof mass pressing on the gas in the gap between it and the outer sensor layer. Damping helps prevent the output of the accelerometer from becoming saturated, as would happen when the resonance of an accelerometer with no damping is excited by random vibration. The advantage of gas damping over liquid damping is that it is minimally affected by temperature changes.

The 3710 series accelerometers contain conditioning circuitry that provides a high sensitivity output. This IC also provides compensation of zero bias and sensitivity errors over temperature

An on-board voltage regulator allows a typical excitation range of 6 to 30 VDC with <30 mA current draw. The 3710 series features a \pm 2 V Full Scale zero based output referenced to power ground. A negative voltage generator provides a sufficient signal swing for negative acceleration outputs with a positive voltage swing of +4.0 V accommodating positive accelerations.

An automated calibration step is conducted at the completion of the accelerometer assembly at discrete temperatures over the specified operating temperature range. The IC features an on-chip temperature sensor for accurate thermal corrections.

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3710 series DC Accelerometer Operating Guide

4.0 Typical Measurement System

The 3710 series DC Accelerometers are available in a uniaxial or triaxial package, with the uniaxial model being the 3711 version and the triaxial model being the 3713 version. The output signal is routed to follow-on signal conditioning via a hermetic four-pin receptacle and associated cable assembly; Model 010 series for the 3711 uniaxial version, and Model 037 series nine-pin cable assembly for the 3713 triaxial version. Since the High Sensitivity DC Accelerometers contain a built-in voltage regulator, they may be powered from virtually any 6 to 30 VDC power source without adversely affecting sensor performance. PCB signal conditioners available are Model 445B01, a single-channel, line powered signal conditioner for the uniaxial 3711series DC accelerometers and Model 478A05, a three-channel, line-powered signal conditioner for the triaxial 3713 accelerometer. Consult PCB Application Engineering for additional signal conditioning options. The output from the signal conditioner is typically routed to readout instrumentation such as oscilloscopes or various model data acquisition instruments.

5.0 Sensor Installation

When choosing an installation technique, be certain to carefully examine the different application characteristics that may affect sensor performance. Characteristics such as mounting location may limit the use of large mounting blocks or the amplitude range may necessitate the use of a stud mount rather than using adhesive. A summary of the recommended mounting methods is provided below.

Stud Mount: Recommended for permanent mount applications or in test situations that require a rugged or secure installation. The necessary information, including surface finish, mounting hole dimensions, and recommended mounting torque for installing the sensor is listed on the enclosed Sensor Installation Drawing. It is recommended that an experienced technician or machinist with good machining capabilities adequately prepare the surface.

Adhesive Mount: Recommended for temporary mounting of the sensor or when the test object surface cannot be properly prepared for stud mounting. Wax works well for temporary mount applications under conditions where the operating temperature will not melt the wax or the acceleration levels will not dislodge the sensor from the test object. Cyanoacrylate-based, "quick-bonding" adhesives provide a quick mounting method, while two-part epoxies can be used for a more secure mount. To remove an adhesively mounted sensor, it is best to place an open-ended wrench over the sensor and twist it to shear the adhesive bond. Striking the sensor with a hammer or other object may permanently damage the sensor.

Easy Mount Clip: Recommended when frequent installation and removal of Series 3710 series accelerometers is desired. The Easy-Mount Clip can either be stud mounted or adhesively mounted to the test structure. (If adhesively mounting the clip, detach the sensor from the clip first, as excessive adhesive may creep through the mounting holes and adhere to the sensor. This will make separation and removal from the clip difficult.) Once the Easy-Mount Clip has been attached to the test structure, the sensor can be easily snapped into and out of the clip. Over time, the Easy-Mount Clip must be replaced as it will "wear-out" and eventually lose its ability to securely hold the sensor.

6.0 Powering

The 3710 Series contains built-in microelectronics that will operate from any PCB Series 445 or Series 478 Sensor Signal Conditioner. These signal conditioners provide the necessary voltage and current required for all of the powering options available on the 3710 series.

The 3710 series may also be powered by other voltage sources such as DC voltage laboratory supplies, automotive or marine batteries, or low-voltage supplies designed for powering PC Board components. If you decide to not use a Series 445 or 478 Series Signal Conditioner, insure that the source provides power within the excitation voltage range listed on the specification sheet for that model. It is important to note that since the accelerometers contain a built-in voltage regulator, precise calibration of the power source is generally not required.

7.0 Operation

After the sensor has been installed and the cable connected for proper operation, there are a couple of measurement points to take note of:

- To take advantage of the DC response of the accelerometer, the readout device must be in a DC coupled state.
 Consult the appropriate manufacturer or product manual for your readout device for details.
- Because the 3710 series can measure static (constant) accelerations, the DC offset voltage will be affected by the positional alignment relative to the Earth's gravity. In other words, when the sensor is mounted perpendicular with the Earth's surface, the offset will equal that as specified on the calibration certificate for "zero-g offset voltage." If the sensor is mounted parallel with the Earth's surface, the sensor will be experiencing 1 g of acceleration and the offset voltage will increase by the sensitivity of the accelerometer.

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- If the sensor is extended, in the case of an integral cable sensor, or a cable length other than 10 ft is used, in the case of sensor with an integral connector, the offset voltage will change. To determine the accelerometer's offset, rotate the unit 90° so that the sensor is on its side with the sensing axis perpendicular to Earth's gravity and record the DC output. This value is the new "zero-g offset voltage."
- To insure that ground loops are not induced, the shield should only be terminated at one end. Typically, the shield of the cable is tied to the sensor housing. If the sensor is mounted with an isolation pad (or other form of electrical isolation) from the test structure, then the shield should be tied to signal ground at the instrumentation end. Otherwise, leave the cable shield floating or not connected at the instrumentation end.

8.0 Sensor Verification

If the sensor has been handled in a rough manner or before using a sensor for a critical measurement application, it is a good idea to verify that the sensor's sensitivity is still within specification. An accurate static calibration of the 3710 series can be performed using the Earth's Gravitational Field as a reference. The sensor can simply be "flipped" (rotated 180°) in the Earth's Gravity to obtain the scaling factor (sensitivity) and DC offset. First, place the accelerometer in a +1g orientation so that the base is resting on the table and the model number is facing up. The sensing axis will be parallel with the Earth's gravity with the sensor experiencing +1g acceleration. Record the DC output by using a DVM. Then rotate the sensor 180° so that the sensor is inverted (the top of the sensor is resting on the table) and the sensor is experiencing -1g acceleration. Record the DC output. To calculate the sensitivity of the accelerometer, refer to equation 8.1.

Sensitivity =
$$\frac{(+1g) - (-1g)}{2}$$
 Eq 8.1

9.0 Sensor Calibration

Due to ISO 9001, ISO Guide 25, or other contractual requirements, it may become necessary to send the accelerometer back to PCB for recalibration. In this case, a complete back-to-back frequency response test will be performed and the "zero-g" offset voltage will be checked with NIST traceable equipment.

10.0 Maintenance and Repair

Because of the sophisticated nature of PCB instrumentation, field repair of the equipment is not recommended. Most PCB sensors are of modular construction and are factory repairable. A repair or replacement quotation is available at no charge. Before returning equipment for repair, it is recommended that the user confer with a factory application engineer (or international representative) to first troubleshoot the problem.

11.0 Return Procedure

To expedite the repair process, contact a factory Application Engineer to obtain a Return Material Authorization (RMA) number prior to sending equipment to the factory. Please have information, such as model number, serial number and description of the problem, available.

Customers outside the U.S. should consult their local PCB distributor for information on returning equipment. For exceptions to this guideline, please contact the International Sales department to request shipping instructions and an RMA.

For further assistance, please call (716) 684-0001 or fax us at (716) 684-0987. You may also receive assistance via e-mail at info@pcb.com or visit our web site at www.pcb.com.

12.0 Customer Service / Warranty

The employees of PCB strive to provide superior, unmatched customer service. Should you at any time find yourself dissatisfied with any PCB product for any reason, consult a factory Application Engineer or local representative/distributor to discuss repair, refund, or exchange procedures.

When unexpected measurement problems arise, call our 24-hour SensorLine $^{\rm TM}$ at (716) 684-0001 to discuss your immediate dynamic instrumentation needs with a PCB Application Engineer.

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